



## Material Content Data Sheet



Sales Product Name	SPA06N60C3			Issued		16. January 2020		
MA#	MA000798044							
Package	PG-TO220-3-253			Weight*		2134.06 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	4.096	0.19	0.19	1919	1919
leadframe	inorganic material	phosphorus	7723-14-0	0.429	0.02		201	
	non noble metal	iron	7439-89-6	1.431	0.07		670	
	non noble metal	copper	7440-50-8	1428.770	66.95	67.04	669507	670378
wire	non noble metal	aluminium	7429-90-5	0.814	0.04	0.04	382	382
encapsulation	organic material	carbon black	1333-86-4	3.364	0.16		1576	
	plastics	epoxy resin	-	131.206	6.15		61482	
	inorganic material	silicondioxide	60676-86-0	538.280	25.22	31.53	252232	315290
leadfinish	non noble metal	tin	7440-31-5	21.462	1.01	1.01	10057	10057
plating	non noble metal	nickel	7440-02-0	1.764	0.08	0.08	826	826
solder	non noble metal	antimony	7440-36-0	0.245	0.01		115	
	noble metal	silver	7440-22-4	0.612	0.03		287	
	non noble metal	tin	7440-31-5	1.591	0.07	0.11	746	1148
*deviation	< 10%	Sum in total:			100.00		1000000	

### Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com